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Kind regards,

Team Nexperia



# NXP3875Y; NXP3875G

50 V, 150 mA NPN general-purpose transistors
Rev. 1 — 12 December 2012

**Product data sheet** 

#### 1. **Product profile**

### 1.1 General description

NPN general-purpose transistors in a small SOT23 (TO-236AB) Surface-Mounted Device (SMD) plastic package.

### 1.2 Features and benefits

- General-purpose transistors
- Small SMD plastic packages
- Two different current gain selections
- AEC-Q101 qualified

### 1.3 Applications

General-purpose switching and amplification

### 1.4 Quick reference data

Table 1. **Quick reference data** 

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
$V_{CEO}$	collector-emitter voltage	open base	-	-	50	V
I <sub>C</sub>	collector current		-	-	150	mΑ
h <sub>FE</sub>	DC current gain	$V_{CE} = 6 \text{ V}; I_{C} = 2 \text{ mA}$				
	NXP3875Y		120	-	240	
	NXP3875G		200	-	400	

#### **Pinning information** 2.

Table 2. **Pinning** 

Pin	Description	Simplified outline	Graphic symbol
1	base		
2	emitter	_ 3	3
3	collector	1 2	1—
			sym021



# 3. Ordering information

Table 3. Ordering information

Type number	Package			
	Name	Description	Version	
NXP3875Y	TO-236AB	plastic surface-mounted package; 3 leads	SOT23	
NXP3875G				

# 4. Marking

Table 4. Marking codes

Type number	Marking code <sup>[1]</sup>
NXP3875Y	*JE
NXP3875G	*JF

<sup>[1] \* =</sup> placeholder for manufacturing site code.

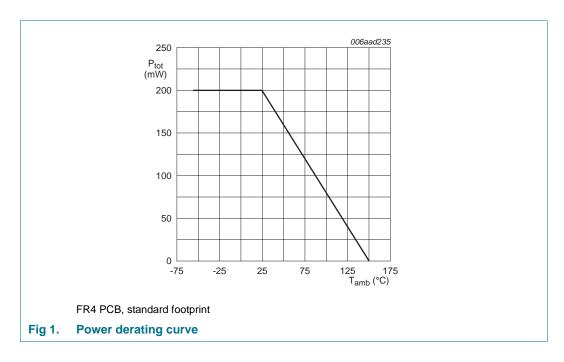
# 5. Limiting values

Table 5. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134).

Symbol	Parameter	Conditions	Min	Max	Unit
$V_{CBO}$	collector-base voltage	open emitter	-	60	V
$V_{CEO}$	collector-emitter voltage	open base	-	50	V
V <sub>EBO</sub>	emitter-base voltage	open collector	-	5	V
I <sub>C</sub>	collector current		-	150	mA
I <sub>CM</sub>	peak collector current	$single \ pulse; \\ t_p \leq 1 \ ms$	-	200	mA
I <sub>B</sub>	base current			30	mA
I <sub>BM</sub>	peak base current	$\begin{array}{l} \text{single pulse;} \\ t_p \leq 1 \text{ ms} \end{array}$	-	100	mA
P <sub>tot</sub>	total power dissipation	$T_{amb} \le 25  ^{\circ}C$	<u>[1]</u> _	200	mW
Tj	junction temperature		-	150	°C
T <sub>amb</sub>	ambient temperature		-65	+150	°C
T <sub>stg</sub>	storage temperature		-65	+150	°C

<sup>[1]</sup> Device mounted on an FR4 Printed-Circuit Board (PCB), single-sided copper, tin-plated and standard footprint.

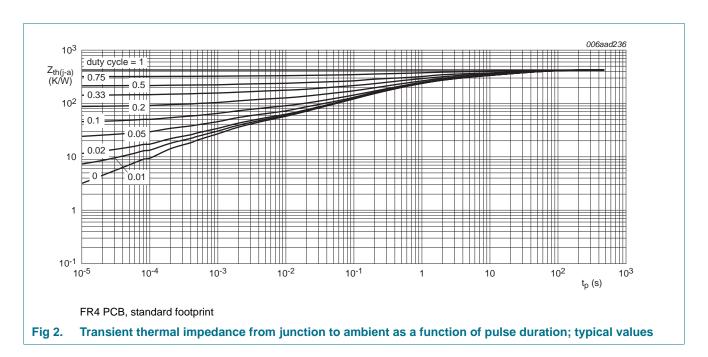


# 6. Thermal characteristics

Table 6. Thermal characteristics

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
$R_{th(j-a)}$	thermal resistance from junction to ambient	in free air	[1] -	-	625	K/W

[1] Device mounted on an FR4 PCB, single-sided copper, tin-plated and standard footprint.



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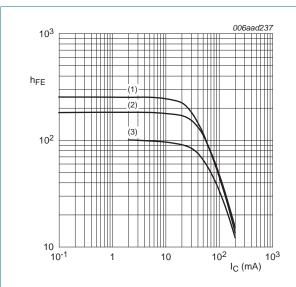
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# 7. Characteristics

Table 7. Characteristics

 $T_{amb} = 25$  °C unless otherwise specified.

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
I <sub>CBO</sub> collector-base cut-off current		$V_{CB} = 60 \text{ V}; I_{E} = 0 \text{ A}$	-	-	100	nA
	cut-off current	$V_{CB} = 60 \text{ V}; I_E = 0 \text{ A};$ $T_j = 150 ^{\circ}\text{C}$	-	-	5	μΑ
I <sub>EBO</sub>	emitter-base cut-off current	$V_{EB} = 5 \text{ V}; I_{C} = 0 \text{ A}$	-	-	100	nA
h <sub>FE</sub>	DC current gain	$V_{CE} = 6 \text{ V}; I_{C} = 2 \text{ mA}$				
	NXP3875Y		120	-	240	
	NXP3875G		200	-	400	
$V_{CEsat}$	collector-emitter saturation voltage	$I_C = 100 \text{ mA}; I_B = 10 \text{ mA}$	-	-	250	mV
$V_{BEsat}$	base-emitter saturation voltage	$I_C = 100 \text{ mA}; I_B = 10 \text{ mA}$	-	-	1	V
f⊤	transition frequency	$V_{CE} = 10 \text{ V}; I_{C} = 1 \text{ mA};$ f = 100 MHz	80	-	-	MHz
C <sub>c</sub>	collector capacitance	$V_{CB} = 10 \text{ V}; I_E = i_e = 0 \text{ A};$ f = 1 MHz	-	-	3.5	pF
NF	noise figure	$I_C = 0.1 \text{ mA}; V_{CE} = 6 \text{ V};$ $R_S = 10 \text{ k}\Omega; f = 1 \text{ kHz};$	-	-	10	dB



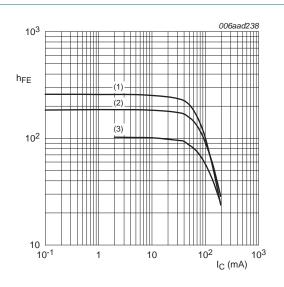
V<sub>CE</sub> = 1 V

(1)  $T_{amb} = 100 \, ^{\circ}C$ 

(2)  $T_{amb} = 25 \, ^{\circ}C$ 

(3)  $T_{amb} = -55 \, ^{\circ}C$ 

Fig 3. NXP3875Y: DC current gain as a function of collector current; typical values



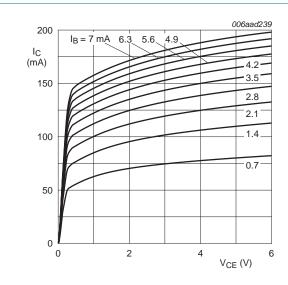
 $V_{CE} = 6 V$ 

(1)  $T_{amb} = 100 \, ^{\circ}C$ 

(2)  $T_{amb} = 25 \, ^{\circ}C$ 

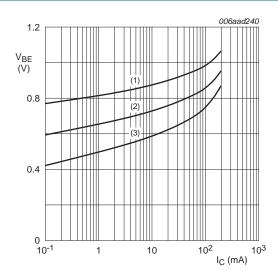
(3)  $T_{amb} = -55 \, ^{\circ}C$ 

Fig 4. NXP3875Y: DC current gain as a function of collector current; typical values



T<sub>amb</sub> = 25 °C

Fig 5. NXP3875Y: Collector current as a function of collector-emmiter voltage; typical values



 $V_{CE} = 6 V$ 

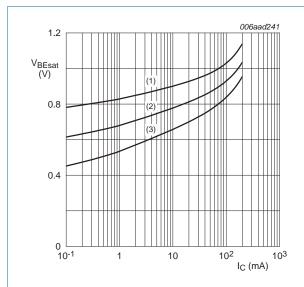
(1)  $T_{amb} = -55 \, ^{\circ}C$ 

(2)  $T_{amb} = 25 \, ^{\circ}C$ 

(3)  $T_{amb} = 100 \, ^{\circ}C$ 

Fig 6. NXP3875Y: Base-emmiter voltage as a function of collector current; typical values

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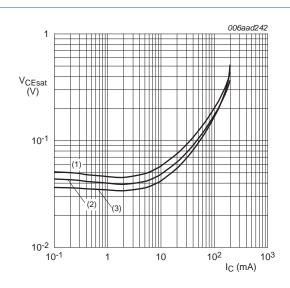
$$I_{\rm C}/I_{\rm B} = 10$$

(1) 
$$T_{amb} = -55 \, ^{\circ}C$$

(2) 
$$T_{amb} = 25 \, ^{\circ}C$$

(3) 
$$T_{amb} = 100 \, ^{\circ}C$$

Fig 7. NXP3875Y: Base-emitter saturation voltage as a function of collector currant; typical values



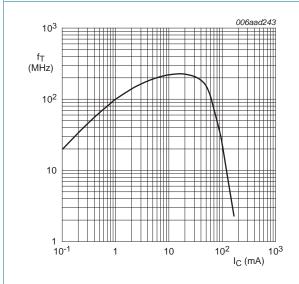
$$I_{\rm C}/I_{\rm B} = 10$$

(1) 
$$T_{amb} = 100 \, ^{\circ}C$$

(2) 
$$T_{amb} = 25 \, ^{\circ}C$$

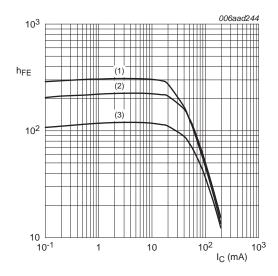
(3) 
$$T_{amb} = -55 \, ^{\circ}C$$

Fig 8. NXP3875Y: Collector-emmiter saturation voltage as a function of collector current; typical values



 $V_{CE}$  = 10 V;  $T_{amb}$  = 25 °C

Fig 9. NXP3875Y: Transition frequency as a function of collector current; typical values



$$V_{CE} = 1 V$$

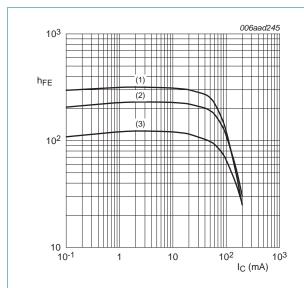
(1) 
$$T_{amb} = 100 \, ^{\circ}C$$

(2) 
$$T_{amb} = 25 \, ^{\circ}C$$

(3) 
$$T_{amb} = -55 \, ^{\circ}C$$

Fig 10. NXP3875G: DC current gain as a function of collector current; typical values

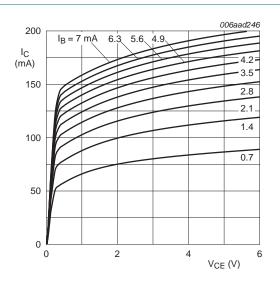
NXP3875Y\_NXP3875G



 $V_{CE} = 6 V$ 

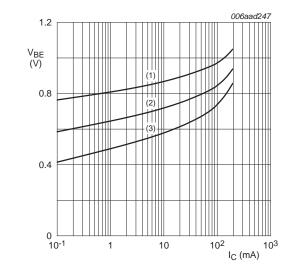
- (1)  $T_{amb} = 100 \, ^{\circ}C$
- (2)  $T_{amb} = 25 \, ^{\circ}C$
- (3)  $T_{amb} = -55 \, ^{\circ}C$

Fig 11. NXP3875G: DC current gain as a function of collector current; typical values



T<sub>amb</sub> = 25 °C

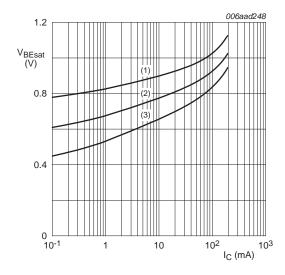
Fig 12. NXP3875G: Collector current as a function of collector-emmiter voltage; typical values



 $V_{CE} = 6 V$ 

- (1)  $T_{amb} = -55 \, ^{\circ}C$
- (2)  $T_{amb} = 25 \, ^{\circ}C$
- (3)  $T_{amb} = 100 \, ^{\circ}C$

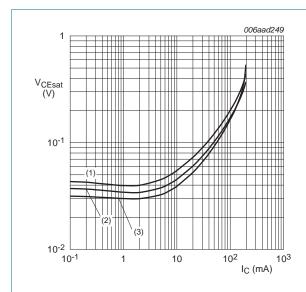
Fig 13. NXP3875G: Base-emmiter voltage as a function of collector current; typical values



 $I_{\rm C}/I_{\rm B} = 10$ 

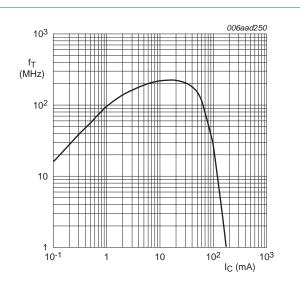
- (1)  $T_{amb} = -55 \, ^{\circ}C$
- (2)  $T_{amb} = 25 \, ^{\circ}C$
- (3)  $T_{amb} = 100 \, ^{\circ}C$

Fig 14. NXP3875G: Base-emitter saturation voltage as a function of collector currant; typical values



- $I_{\rm C}/I_{\rm B} = 10$
- (1)  $T_{amb} = 100 \, ^{\circ}C$
- (2)  $T_{amb} = 25 \, ^{\circ}C$
- (3)  $T_{amb} = -55 \, ^{\circ}C$

Fig 15. NXP3875G: Collector-emmiter saturation voltage as a function of collector current; typical values



 $V_{CE}$  = 10 V;  $T_{amb}$  = 25 °C

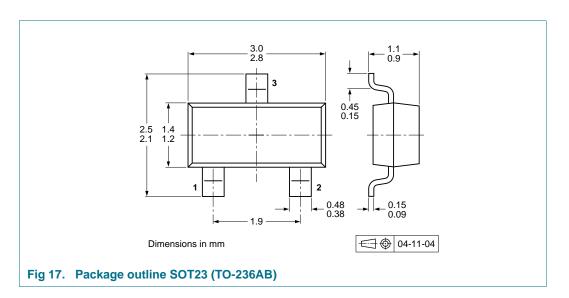
Fig 16. NXP3875G: Transition frequency as a function of collector current; typical values

### 8. Test information

### 8.1 Quality information

This product has been qualified in accordance with the Automotive Electronics Council (AEC) standard *Q101 - Stress test qualification for discrete semiconductors*, and is suitable for use in automotive applications.

# 9. Package outline



# 10. Packing information

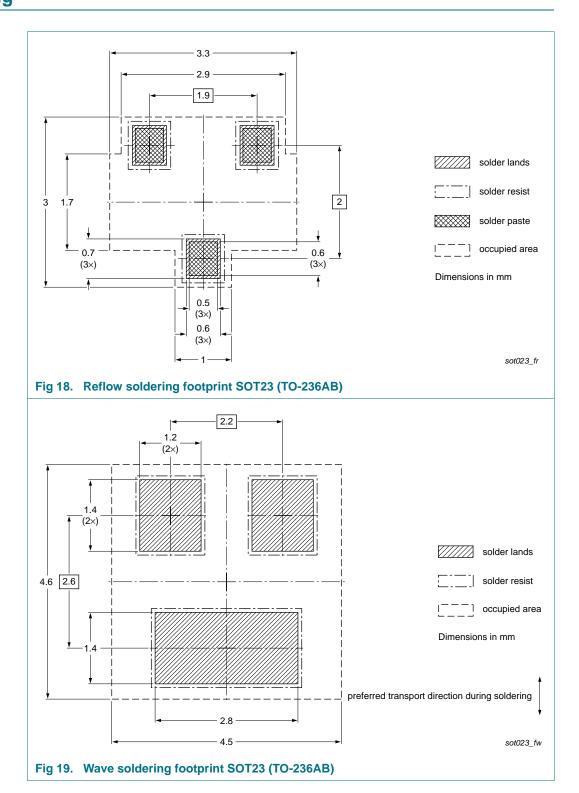
Table 8. Packing methods

The indicated -xxx are the last three digits of the 12NC ordering code.[1]

Туре	Package	Description	Packing quantity	
number			1000	4000
NXP3875Y	SOT23	4 mm pitch, 8 mm tape and reel	-215	-235
NXP3875G				

<sup>[1]</sup> For further information and the availability of packing methods, see  $\underline{\text{Section 14}}$ .

# 11. Soldering



NXP3875Y\_NXP3875G

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# 12. Revision history

### Table 9. Revision history

Document ID	Release date	Data sheet status	Change notice	Supersedes
NXP3875Y_NXP3875G v.1	20121212	Product data sheet	-	-

## 13. Legal information

#### 13.1 Data sheet status

Document status[1][2]	Product status[3]	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
Product [short] data sheet	Production	This document contains the product specification.

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# **NXP3875Y; NXP3875G**

### 50 V, 150 mA NPN general-purpose transistors

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Date of release: 12 December 2012
Document identifier: NXP3875Y\_NXP3875G